



1374.20289RC6

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. MAEJIMA, et al.

Serial No: 09/704,529

Filed: November 3, 2000

Title: WAFER HAVING CHAMFERED BEND PORTIONS IN THE
JOINT REGIONS BETWEEN THE CONTOUR OF THE WAFER
AND THE CUT-AWAY PORTION OF THE WAFER

Group: 2814

Examiner: L. PHAM

AMENDMENT AFTER FINAL REJECTION

Box: AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

January 29, 2007

Sir:

In response to the Office Action dated December 5, 2006, please
amend the above-identified application as listed below and as set forth on the
following pages:

Amendments to the Claims

Remarks are included following the amendments

don't
enter
LP (4/19/07)

AF
JPW